

Examiner : A. Chambliss

Art Unit : 2827

Docket No.: 52433/544

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.

Serial No. : 09/254,118

Filed : May 19, 1999

For : METHOD OF PARTIALLY PLATING SUBSTRATE FOR

ELECTRONIC DEVICES

Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the above-identified patent application.

[X] No additional fee is required.

The fee has been calculated as shown below.

			SMALL EN	SMALL ENTITY		OTHER THAN A SMALL ENTITY	
CLAIMS	HIGH	EST NO.	RATE	ADDIT. OR	RATE	ADDIT.	
REMAINING	PREVIOUS	LY PRESEN	1T	FEE		FEE	
AFTER	PAID	FOR EX	TRA				
AMENDMENT							
TOTAL 10 M	MINUS 20	= 0	x6=	\$	x18 = \$	0.00	
INDEP. 1 M	INUS 3	= 0	x 18=	\$	x 86 = \$	0.00	
[]FIRST PRESE	ENTATION OF	MULTIPLE	x 60=	\$	x290= \$	0.00	
DEP. CLAIM TOTAL							
		IA	DIT. FEE	\$ OR	\$_	0.00	

[X] The Commissioner is hereby authorized to charge fees under 37 CFR 1.16 and 1.17 which may be required to Deposit Account 11-0600. A duplicate of this

paper is enclosed.

[X] A petition for a two (2) month extension of time and Deposit Account

authorization to cover the extension fee are enclosed.

[] Terminal Disclaimer and Deposit Account Authorization.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450,

Alexandria, VA 22313-1450, on November 4, 2004

John J. Kelly, Jr. Reg. No. 29,182

Respectfully submitted,

KENYON & KENYON

John J. Kelly, Jr.

Reg. No. 29,182